ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES INDUSTRIES	annockburn, Illinois, A	ll rights reserved une tions.	der both leve	s documer el parts, th	nt is a declaration ne declaration en	n of the substance compasses all low	es within the manufactur wer level materials for w	er listed ite hich the ma	m. Note: if t nufacturer h	he item is an as as engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					1			
Supplier Information												
ompany name* Company unique ID			Unique ID Authority				Response Date*					
onsemi	ni								2024-05-05			
Contact Name	Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards	o Compliance		r	NA			Product-Env-Stewards@onsemi.com					
Requester Item Number N	Ifr Item Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		'eight*	UOM	Unit Type	
A	MIS30512C5122RG	IS30512C5122RG C512 - INDUSTRI		:	2024-05-05		BE4	73	32.93	mg	Each	
Manufacturing Proccess Information								<u> </u>				
Terminal Plating / Grid Array Material	Material Terminal Base Alloy		STD-020 MSL Rat	ting	Peak Process Body Temperature Max Time		ture Max Time at Peak	k Temperature Number of Reflow Cycles		les		
Matte Tin (Sn) - annealed CU Alloy 2					260	С	30	second	s 3			
Comments												
ATTENTION: MSL 2 Rated item requires Dry	Pack (after electrical	test)										
for more information regarding material comp	osition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	35.93	mg	Supplier	Silicon (Si)	7440-21-3		35.93	mg	
Die Attach	6.55	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		1.5065	mg	
			Supplier	Silver (Ag)	7440-22-4		5.0435	mg	
Lead Frame	220.88	mg	Supplier	Zinc (Zn)	7440-66-6		0.2209	mg	
			Supplier	Iron (Fe)	7439-89-6		5.0802	mg	
			Supplier	Copper (Cu)	7440-50-8		215.358	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.2209	mg	
Mold Compound-Black	464.15	mg		Epoxy Phenol Resin	proprietary data		48.7357	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		415.4142	mg	
Plating	4.44	mg	Supplier	Tin (Sn)	7440-31-5		4.44	mg	
Wire Bond - Au	0.98	mg	Supplier	Gold (Au)	7440-57-5		0.98	mg	